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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:	§	Art Unit:	2814
Ilya Karpov et al.	§		
	§	Examiner:	Long Pham
Serial No.: 10/822,361	§		
	§	Docket:	ITL.0835D1US
Filed: April 12, 2004	§		P14730D
	§		
For: Fabricating Deeper and	§	Assignee:	Intel Corporation
Shallower Trenches in	§		
Semiconductor Structures	§	Conf. No.	3077

Mail Stop **Amendment**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO OFFICE ACTION

Sir:

In response to the office action mailed March 21, 2007, please amend the above-referenced patent application as follows:

Date of Deposit: June 11, 2007
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
Cynthia L. Hayden
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